

APPLICANT FACSIMILE OF FORM PTO-1449 REV. 07-80	U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE	ATTY DOCKET NO <b>SMQ-080RCE</b>	SERIAL NO. <b>09/935,385</b>
LIST OF PUBLICATIONS CITED BY APPLICANT (Use several sheets if necessary)		APPLICANT <b>Gold, Spencer M. et al.</b>	
		FILING DATE <b>August 22, 2001</b>	GROUP <b>2829</b>

## U.S. PATENT DOCUMENTS

EXAMINER INITIAL		DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE
pk	A1	3,379,214	4/68	Weinberg	137	625.5	—
	A2	4,165,642	8/79	Lipp	73	362SC	—
	A3	4,201,087	5/80	Akita <i>et al.</i>	73	339A	—
	A4	4,305,041	12/81	Frerking	328	155	—
	A5	4,371,271	02/83	Bellet	374	183	—
	A6	4,551,031	11/85	Ishikawa <i>et al.</i>	374	117	—
	A7	4,559,954	12/85	Murase	128	736	—
	A8	4,658,407	04/87	Iwama	377	25	—
	A9	4,692,710	08/87	Shvartsman	328	111	—
	A10	4,754,760	07/98	Fukukita <i>et al.</i>	128	660	—
	A11	4,905,701	3/90	Cornelius	128	660.01	—
	A12	5,085,526	02/92	Sawtell <i>et al.</i>	374	101	—
	A13	5,193,387	3/93	Hodate	73	146.5	—
pk	A14	5,214,668	5/93	Satou <i>et al.</i>	374	117	—

## FOREIGN PATENT DOCUMENTS

[illegible]

OTHERS (including Author, Title, Date, Pertinent Pages, Etc.)

<i>ph</i>	A15	Dallas Semiconductor, Application Note 105, "High Resolution Temperature Measurement With Dallas Direct-to-Digital Temperature Sensors" Retrieved from the Internet, <a href="http://www.dalsemi.com">www.dalsemi.com</a> , pp. 1-20 (August 11, 1999);
<i>ph</i>	A16	Dallas Semiconductor, Product Guide, "DS1721 2-Wire Digital Thermometer and Thermostat" pp. 1-14 (December 29, 1998);
<i>ph</i>	A17	Gunther <i>et al.</i> "Managing the impact of increasing microprocessor power consumption." pp.1-9 <a href="http://www.intel.com/technology/iti/q12001/articles/art_4.htm">http://www.intel.com/technology/iti/q12001/articles/art_4.htm</a> (2001) Intel Technology Journal Q1
<i>ph</i>	A18	Intel Corporation 2000, Product Guide "Intel® Pentium® 4 Processor In the 423-pin Package Thermal Design Guidelines" Order Number:249203-001, pp. 1-28 (November 2000);
<i>ph</i>	A19	Intel Corporation "Mobile Pentium® II Processor and Pentium II Processor Mobile Module Thermal Sensor Interface specifications." 13 pages (April 1998) <a href="http://www.intel.com/design/mobile/applnots/24372401.pdf">http://www.intel.com/design/mobile/applnots/24372401.pdf</a>
<i>ph</i>	A20	Maxim Integrated Products "Maxim Remote/Local Temperature Sensor with SMBus Serial Interface: MAX1617" pp. 1-20 (March 1998).
Examiner		Date Considered
<i>Parash</i>		<i>02/05/04</i>
<p>*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.</p>		



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EXAMINER INITIAL		DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE
<i>Al</i>	B1	5,546,810	8/96	Arikawa <i>et al.</i>	73	702	—
	B2	5,485,127	01/96	Bertoluzzi <i>et al.</i>	331	69	—
	B3	5,490,059	02/96	Mahalingaiah <i>et al.</i>	364	166	—
	B4	5,097,198	3/92	Holmdahl	323	280	—
	B5	5,291,607	03/94	Ristic <i>et al.</i>	395	750	—
	B6	5,626,425	5/97	Fujikawa <i>et al.</i>	374	163	—
	B7	5,638,418	6/97	Douglass <i>et al.</i>	377	25	—
	B8	5,781,075	7/98	Bolton, Jr. <i>et al.</i>	331	176	—
	B9	5,781,718	07/98	Nguyen	395	183.09	—
	B10	5,832,048	11/98	Woodman, Jr.	375	376	—
	B11	5,836,691	11/98	Yamauchi	374	117	—
	B12	5,838,578	11/98	Pippin	364	488	—
	B13	5,870,614	02/99	Ang	395	750.03	—
	B14	5,892,408	4/99	Binder	331	44	—
	B15	5,892,448	4/99	Fujikawa <i>et al.</i>	340	584	—
	B16	5,933,039	08/99	Hui <i>et al.</i>	327	262	—
	B17	6,115,441	09/00	Douglass <i>et al.</i>	377	25	—
	B18	5,873,053	2/99	Pricer <i>et al.</i>	702	130	—
	B19	5,953,640	9/99	Meador <i>et al.</i>	455	73	—
	B20	6,098,030	8/00	McMinn, Brian S.	702	132	—
	B21	6,219,723 B1	04/01	Hetherington <i>et al.</i>	710	18	—
	B22	2001/0021217 A1	9/01	Gunther <i>et al.</i>	374	178	—
	B23	6,362,699 B1	3/02	Fry	331	176	—
	B24	6,363,490 B1	3/02	Senyk, Borys S.	713	300	—
	B25	6,463,396 B1	10/02	Nishigaki, Nobutaka	702	132	—
	B26	2003/0158697 A1	8/03	Gold <i>et al.</i>	702	132	—
	B27	2003/0156622 A1	8/03	Gold <i>et al.</i>	374	170	—
<i>Al</i>	B28	2003/0158696 A1	8/03	Gold <i>et al.</i>	702	132	—


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